

MN12861

CMOS 1-chip Peripheral LSI for 16-bit MPU

■ Outline

The MN12861 is a multifunctional peripheral LSI which can interface with Intel 16-and 8-bit microprocessors(MPUs).It is a CMOS 1-chip LSI which integrates functions such as clock generation,timer/counter,general purpose I/O,interrupt control,etc.on a single chip.

A combination of the MN12861 and MPU enables the most compact and advanced microcomputer system configuration.

■ Features

- 4 functions integrated on 1 chip

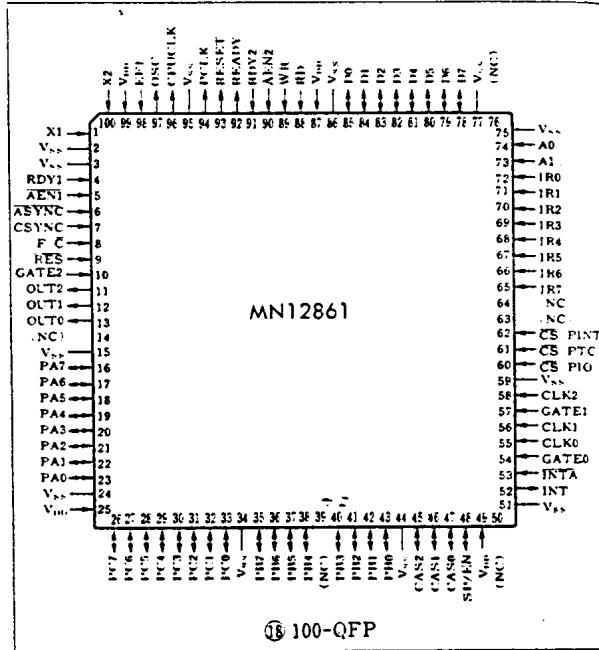
- 1)Clock generator
- 2)Programmable timer/counter
- 3)Programmable I/O
- 4)Programmable interrupt control

Each function is compatible with Intel 8-bit/16-bit peripheral device. Terminals of each function block are all separately provided for wide general purpose properties.

(Bus line and control line from the MPU are common)

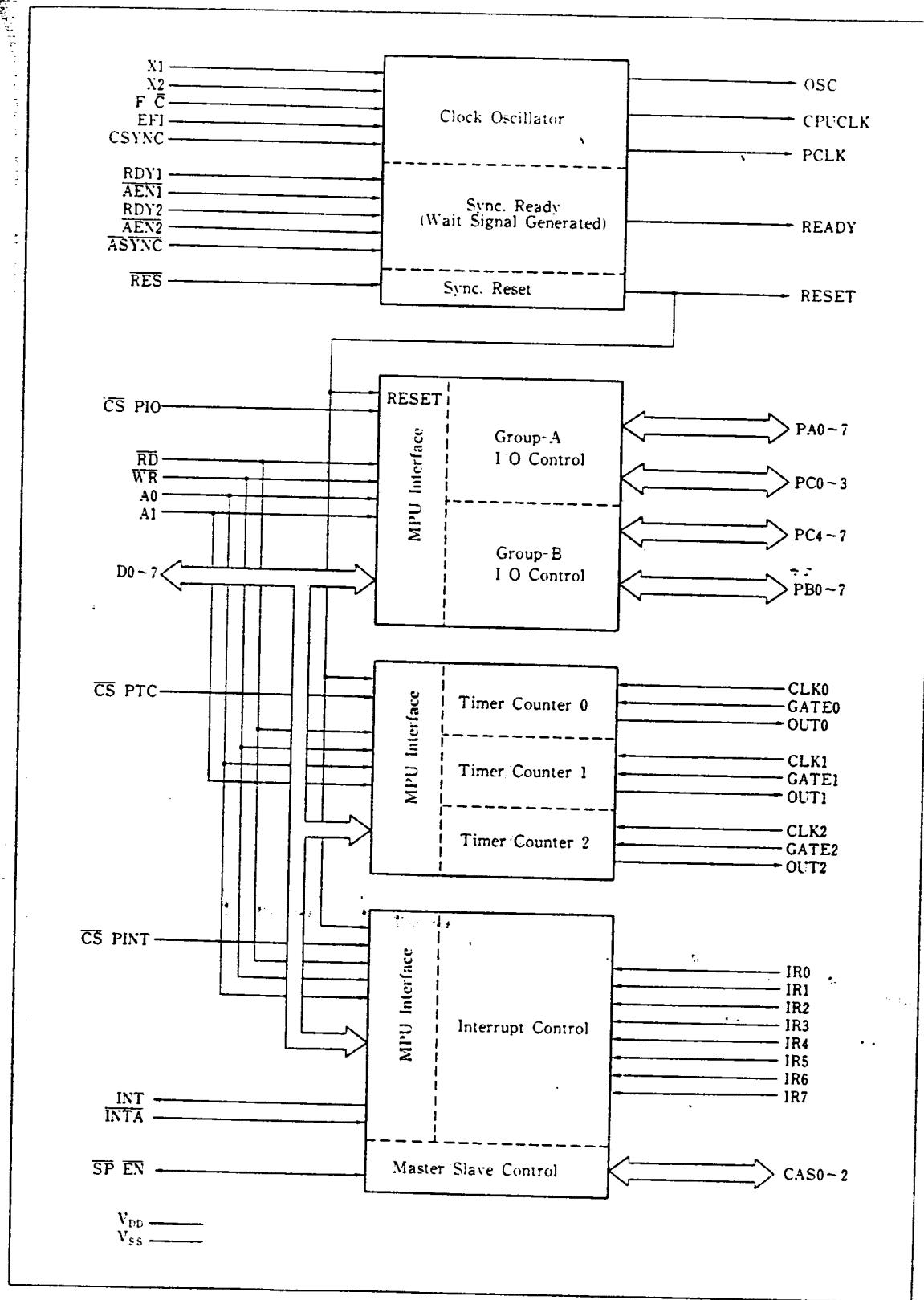
- 5 V single power,TTL compatible I/O
- Low power consumption due to CMOS process
- 100-pin flat package
- Target MPUs
 - Intel 8086/88,8085A or their equivalents
 - Zilog Z-80 or its equivalents
 - The 8086/88 can be interfaced up to an 8 MHz version.

■ Pin Configuration



100-QFP

■ Block Diagram



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■ Pin Descriptions

Pin No.	Name	I/O	Description
85	D0	I/O	Interface pin related to CPU data. Used for reading and writing register, counter, etc. in each function block. It also serves as a vector address interrupt read pin from the CPU. It becomes an output pin at read time and as an input pin at write time.
84	D1	I/O	
83	D2	I/O	
82	D3	I/O	
81	D4	I/O	
80	D5	I/O	
79	D6	I/O	
78	D7	I/O	
74	A0	I	
73	A1	I	Specifies the addresses of the register, counter, latch and port in each function block which is read/written from the CPU.
89	WR	I	Low-level Active control signal which writes data from the CPU to the MN12861. Data is written at a pulse rise edge. When a write/read control signal(RD, INTA) is set to the High level together with this signal, D0-D7 are fixed at high impedance.
88	RD	I	Low-level Active control signal which reads data from the MN12861 to the CPU. When a read control signal(WR, INTA) is set to the High level together with this signal, D0-D7 are fixed at high impedance.
61	CSPTC	I	When this pin is set to the Low level, either read signal(RD) or write signal(WR) becomes valid and it is enabled to read/write data from the CPU to the timer/counter of the MN12861.
60	CSPIO	I	When this pin is set to the Low level, either read signal(RD) or write signal(WR) become valid and it is enabled to read/write data from the CPU to the I/O of the MN12861.
62	CSPINT	I	When this pin is set to the Low level, either(RD) or write(WR) signal becomes valid, and it is enabled to read/write data from the CPU to the interrupt controller of the MN12861.
1 100	X1 X2	I I	Connects to a self-oscillating crystal oscillator and generates oscillations at a frequency 3 times higher than the CPUCLK signal. Used with the F/C pin set to the Low level.
4 91	RDY1 RDY2	I I	Informs the CPU that the device on the system bus completed reception or is ready to send. Valid when AEN1=0 with RDY1=1, or AEN2=0 with RDY2=1, and outputs "1" to the READY pin.
5 90	AEN1 AEN2	I I	AEN1 validates RDY1, and AEN2 RDY2, respectively; both Low-level Active signals.
6	ASYNC	I	Selects a RDY signal synchronizing method when either RDY1 or RDY2 is made valid. At the Low level, the READY signal is outputted after 2-time synchronization. When set to the High level or opened, the READY signal is outputted after 1-time synchronization.

■ Pin Descriptions(Continued)

Pin No.	Name	I/O	Description
7	CSYNC	I	Synchronizing signal to output in-phase clocks as other clock generators of the MN12861 or the Intel 82S4A. An internal counter is reset at the High level. When set to the Low level, the internal counter starts counting. CSYNC is externally synchronized with EFI input. Fix at GND when using internal self-oscillation.
8	F.C	I	Selects a CPUCLK PCLK clock source. A crystal oscillation clock is selected as a source when set to the Low level, and EFI input clock when set to the High level. At the High level, self-oscillation stops.
9	RES	I	Input pin for RESET signal generation. It combines with an in-chip I/O reset signal. It is a Schmidt trigger level input pin. Once the reset signal is inputted from the RES pin, the CAS0-CAS2 pins remain at high impedance until a mode is set for the interrupt controller.
98	EFI	I	When the F.C input pin is set to the High level, EFI input becomes a clock source for CPUCLK and PCLK.
97	OSC	O	Self-oscillation output with the same frequency as an oscillation one. This pin is not affected if CSYNC is set to the High level.
96	CPUCLK	O	System clock supplied to the CPU or its local bus device. Outputs a high-level clock(duty 1/3) of 1/3-divided crystal oscillation frequency or EFI input clock frequency.
94	PCLK	O	Clock signal for a peripheral device. Outputs a 1/2 duty clock of 1/2-divided CPUCLK clock frequency.
93	PRESET	O	CPU reset signal which also serves as a in-chip I.O reset signal. If RES input is set to the Low level, the RESET signal is synchronized with the High level to be outputted. If reset is made valid from the I/O, all the I/O pins of PA, PB and PC are fixed at the Mode 0 input state. The control register in the I.O section is also cleared.
92	READY	O	RDY1/RDY2 synchronized signal and High-level Active. This pin is set to the High level if either one of input signals RDY1 and RDY2 becomes active.
55 56 58	CLK0 CLK1 CLK2	I	Clock input signals to relevant timers/counters. Down-counting starts at a fall of CLK input if a count number is set.
13 12 11	OUT0 OUT1 OUT2	O	Outputs from relevant timers/counters. Output waveforms of specified modes are outputted synchronously with respective CLK signals. Also available as interrupt signals to the CPU.

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■ Pin Descriptions(Continued)

Pin No.	Name	I/O	Description
54	GATE0	I	
57	GATE1	I	
10	GATE2	I	Starts/stops and resets counting in accordance with a relevant timer/counter set mode.
23	PA0	I/O	Serves as an input port, output port or bidirectional port depending on mode setting. Input or output is controlled by Port C relevant bits in the Mode 1 or 2.
22	PA1	I/O	
21	PA2	I/O	
20	PA3	I/O	
19	PA4	I/O	
18	PA5	I/O	
17	PA6	I/O	
16	PA7	I/O	
43	PB0	I/O	Serves as an input port or output port depending on mode setting. Input or output is controlled by Port C relevant bits in the Mode 1. The port B does not have the Mode 2.
42	PB1	I/O	
41	PB2	I/O	
40	PB3	I/O	
38	PB4	I/O	
37	PB5	I/O	
36	PB6	I/O	
35	PB7	I/O	
33	PC0	I/O	Lower 4 bits of the port C. Serves as a 4-bit input or output port depending on mode setting of Group B including the Port B. In the Mode 1, PC0-PC2 are I/O control bits of the Port B, and remaining PC3 depends on Mode setting of Group A including the Port A. When Group A is in the Mode 1 or 2, PC3 becomes an interrupt output signal concerned with the Port A.
32	PC1	I/O	
31	PC2	I/O	
30	PC3	I/O	
29	PC4	I/O	Upper 4 bits of the Port C. Serves as a 4-bit input or output port depending on mode setting of Group A including the Port A. In case of Mode-1 input, PC3-PC5 serve as Port A input pins. In Mode-1 output, PC3, PC6 and PC7 serve as Port A output control pins.
28	PC5	I/O	
27	PC6	I/O	
26	PC7	I/O	

Port	Group B	
	Mode 0	Mode 1
PC0	I/O	INTRB/INTRB
PC1	I/O	IBFB/OBFB
PC2	I/O	STBB/ACKB
PC3	I/O	INTRA I/O
	Mode 0	Mode 1/2
		Mode 0
	Group A	

Port	Group A		
	Mode 0	Mode 1	Mode 2
PC4	I/O	STBA/I/O	STBA
PC5	I/O	IBFA/I/O	IBFA
PC6	I/O	I/O/ACKA	ACKA
PC7	I/O	I/O/OBFA	OBFA

■ Pin Descriptions(Continued)

Pin No.	Name	I/O	Description
72	IR0	I	
71	IR1	I	
70	IR2	I	
69	IR3	I	
68	IR4	I	
67	IR5	I	
66	IR6	I	
65	IR7	I	
53	INTA	I	Read signal outputted in a CPU interrupt processing sequence in order to read an interrupt vector.
52	INT	O	Interrupt request signal outputted to the CPU when IR input to the interrupt controller is received. High level. Active.
48	SP/EN	I/O	Low-level Active pin which serves as input or output depending on mode setting. Serves as an output pin in the buffer mode. A control pulse is outputted in order to enable the buffer transceiver. Serves as an input pin in the non-buffer mode and allows setting High level=Master/Low level=Slave. Interrupt input can be extended by externally attaching the Intel 8259A to the MN12861.
47	CAS0	I/O	
46	CAS1	I/O	
45	CAS2	I/O	

■ Outline of Functions

(1) Clock generator

- Source clock generation(max. 24MHz)
- CPU clock generation for the 8086/88(max. 8 MHz; duty 1/3)
- Peripheral clock generation for 8086/88(max. 4 MHz)
- CPU Ready(wait end) signal output
- Clock synchronization
- Reset signal output(MN12861 system reset combined)

(2) Programmable Timer/Counter

- 16-bit timer/counter × 3(independent)
- Binary BCD count system
- Count frequency DC 5 MHz
- 6 operation modes:
 - 0: Interrupt at count end
 - 1: Programmable one shot
 - 2: Rate generator
 - 3: Square wave rate generator
 - 4: Software trigger strobe(strobe pulse generation at count end)
 - 5: Hardware trigger strobe(starts the operation above by trigger input)

(3) Programmable I/O

- 3-port(Ports A, B and C, 24 bits) I/O
 - Bit setting/resetting allowed for the Port C
 - 3-mode I/O operation
 - 0: I/O per byte(I/O by 4 bits allowed for the Port C only)
 - 1: Applied to the Ports A and B. Port C specific bits provide other port's I/O control and buffer status output(interrupt output included).
 - 2: Applied to the Port A only. Port C specific 5 bits provide I/O control and buffer status output(interrupt output included), and provide handshaking through the Port A. The Port A serves as a bidirectional I/O pin.
 - Initialization of other function blocks by the system reset pin.
- (4) Programmable Interrupt Control
- Target MPU: 8086/88, 8085A, 80286 and Z-80
 - Interrupt input: 8, up to 64 by selecting the master/slave(eight 8259As externally attached)
 - Interrupt vector address outputted in accordance with an interrupt level
 - Interrupt mask and interrupt priority level programmable

■ Absolute Maximum Ratings($V_{SS} = 0V$, $T_a = 25^\circ C$)

Item	Symbol	Rating	Unit
Supply voltage	V_{DD}	-0.3~7.0	V
Input pin voltage	V_{IN}	-0.3~ V_{DD} +0.3	V
Output pin voltage	V_{OUT}	-0.3~ V_{DD} +0.3	V
Power dissipation	P_T	500	mW
Operating temperature	T_{opr}	-20~+75	°C
Storage temperature	T_{sig}	-65~+150	°C

■ Operating Conditions

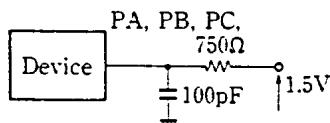
Item	Symbol	Condition	min.	typ.	max.	Unit
Supply voltage	V_{DD}		4.5	5.0	5.5	V
Operating temperature	T_{opr}		-20		75	°C

■ Electrical Characteristics

● DC Characteristics ($V_{DD} = +5V \pm 10\%$, $T_a = -20$ to $+75^\circ C$)

Item	Symbol	Condition	min.	typ.	max.	Unit
Input voltage low level	V_{IL}		-0.3		0.8	V
Input voltage high level	$V_{IH(1)}$	RES	2.6		$V_{IL}-0.3$	V
	$V_{IH(2)}$	Other than RES	2.2		$V_{IL}-0.3$	V
Output voltage low level	$V_{OL(1)}$	CPUCLK, PCLK $I_{OL}=5mA$ OSC,READY,RESET			0.45	V
	$V_{OL(2)}$	DB0~7 $I_{OL}=2.5mA$ PA0~7 PB0~7 PC0~7			0.45	V
	$V_{OL(3)}$	Output pins other than the above $I_{OH}=2.2mA$			0.45	V
Output voltage high level	$V_{OH(1)}$	CPUCLK $I_{OH}=-1mA$	4.0			V
	$V_{OH(2)}$	PCLK, OSC $I_{OH}=-1mA$ READY, RESET	2.8			V
	$V_{OH(3)}$	INT $I_{OH}=-100\mu A$	3.5			V
	$V_{OH(4)}$	Output pins other than the above $I_{OH}=-400\mu A$	2.4			V
Input hysteresis voltage	V_{INHR} $-V_{INLR}$	RES pin only	0.25			V
Darlington drive current	I_{DAR}	PA0~7 PB0~7 8pins out of them (Note) PC0~7	-1			mA
Input leakage current	$I_{LI(1)}$	IR0~7 $V_{IN}=0 \sim V_{DD}$	-300		10	μA
	$I_{LI(2)}$	ASYNC $V_{IN}=0 \sim V_{DD}$	-200		10	μA
	$I_{LI(3)}$	Input pins other than the above $V_{IN}=0 \sim V_{DD}$	-10		10	μA
Output leakage current	I_{LO}	$V_{OUT}=0 \sim V_{DD}$	-10		10	μA
Standby current	I_{DDST}	At initialize time, output pins opened and input pin level fixed (pull-up pins: High level)			0.5	mA
Supply current	I_{DD}	Output pin no-load, $f_{CLK0-2}=5$ MHz, $f_{osc}=24MHz, 8086-2(8MHz)$ assumed to be used			80	mA

Note) Measure with the following circuit.



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● Capacitance($V_{DD} = GND = OV$, $T_a = 25^\circ C$)

Item	Symbol	Condition	min.	typ.	max.	Unit
Input capacitance	C_{IN}	Other than $f_c = 1MHz$ measured pins. Fixed at 0V Note)			10	pF
Output capacitance(at high impedance)	C_{OUT}	Other than $f_c = 1MHz$ measured pins. Fixed at 0V Note)			20	pF

Note) The X1, X2, OSC, CPUCLK, PCLK, READY and RESET pins are excluded.

● AC Characteristics (1) MPU Interface($V_{DD} = 5V \pm 10\%$, $T_a = -20$ to $+75^\circ C$)

Item	Symbol	Condition	min.	typ.	max.	Unit
[Read Cycle]						
Address(\overline{CS} , A0, A1) stable time Note)	$t_{AR(1)}$	Timer/counter	30			ns
	$t_{AR(2)}$	I/O, interrupt controller	0			ns
Address(\overline{CS} , A0, A1) holding time Note)	t_{RA}		0			ns
RD pulse width	t_{RR}		150			ns
Read data delay time	t_{RD}	$CL = 150pF$			120	ns
Read data floating time	t_{RF}	$CL = 20 pF, RL = 2K\Omega$	10		85	ns
[Write Cycle]						
Address(\overline{CS} , A0, A1) stable time Note)	t_{AW}		0			ns
Address(\overline{CS} , A0, A1) holding time Note)	t_{WA}		0			ns
WR pulse width	$t_{WW(1)}$	Timer/counter	160			ns
	$t_{WW(2)}$	I/O,interrupt controller	120			ns
Write data setting time	$t_{DW(1)}$	Timer/counter, interrupt controller	120			ns
	$t_{DW(2)}$	I/O	100			ns
Write data holding time	t_{WD}		0			ns
[Read, Write Bus Recovery Time]						
Read recovery time	$t_{RV(1)}$	Timer/counter, I/O	200			ns
	$t_{RV(2)}$	Interrupt controller	160			ns
Write recovery time	$t_{WV(1)}$	Timer/counter, I/O	200			ns
	$t_{WV(2)}$	Interrupt controller	190			ns
Read/write recovery time	$t_{RWV(1)}$	Timer/counter, I/O, interrupt controller	200			ns
	$t_{RWV(2)}$	Interrupt controller, INTA-RD/WR	250			ns

Note) \overline{CS} means \overline{CS}_{PTC} , \overline{CS}_{PIO} , \overline{CS}_{PINT} .

● AC Characteristics 2) Clock Generator($V_{DD} = 5V \pm 10\%$, $T_a = -20$ to $+75^\circ C$)

	Item	Symbol	Condition	min.	typ.	max.	Unit
EFI	High-level width	t_{EEL}	90% - 90% V_{IN}	13			ns
	Low-level width	t_{EELH}	10% - 10% V_{IN}	13			ns
	Cycle	t_{EEL}	Note 1)	41.6			ns
Quartz frequency		f_{osc}		8		24	MHz
RDY1	Active setting time	t_{RIVCL}	$ASYNC = HIGH$	35			ns
	(to CPUCLK)	t_{RIVCH}	$ASYNC = LOW$	35			ns
RDY2	Inactive setting time (to CPUCLK)	t_{RIVCL}		35			ns
	Holding time (to CPUCLK)	t_{CLRIX}		0			ns
ASYNC	Setting time(to CPUCLK)	t_{AYVCL}		50			ns
	Holding time(to CPUCLK)	t_{CLAYX}		0			ns
AEN1 AEN2	Setting time(to RDY1, RDY2)	t_{AIVRIV}		15			ns
	Holding time (to CPUCLK)	t_{CLAIX}		0			ns
CSYNC	Setting time (to CPUCLK)	t_{YHEH}		20			ns
	Holding time (to CPUCLK)	t_{EHYL}		10			ns
	Pulse width	t_{YHYL}		$2-t_{EEL}$			ns
RES	Setting time (to CPUCLK)	t_{IIHCL}	Note 1)	65			ns
	Holding time (to CPUCLK)	t_{CLIIH}	Note 1)	20			ns
Input rise time		t_{ILIH}	0.8~2.0V			20	ns
Input fall time		t_{IHIL}	2.0~0.8V			12	ns
CPUCLK	Cycle	t_{CKLCXL}		125			ns
	High-level width	t_{CKHCL}	See Measuring Circuit Diagrams 3 and 4.	(1 3 t_{CKCL}) -2			ns
	Low-level width	t_{CKLCXH}	See Measuring Circuit Diagrams 3 and 4.	(2 3 t_{CKCL}) -15			ns
	Rise time	t_{CHICH2}	1.0V ~ 3.5V			10	ns
	Fall time	t_{CL2CLI}	3.5V ~ 1.0V			10	ns
PCLK	High-level width	t_{PHPL}		$t_{CK}-20$			ns
	Low-level width	t_{PLPH}		$t_{CK}-20$			ns
READY	Inactive time (to CPUCLK) Note 2)	t_{RYLCL}	See Measuring Circuit Diagrams 5 and 6.	-8			ns
	Active time (to CPUCLK) Note 3)	t_{RYHCH}	See Measuring Circuit Diagrams 5 and 6.	(2 3 t_{CK}) -15			ns

Note 1) Required only when assuring an acceptance by the next clock.

Note 2) Applied to the T2 state.(For meaning of the T2 state, see Intel MPU8086 '88)

Note 3) Applied to the T3 and TW states only.(For meanings of the T3 and TW states, see Intel MPU8086 '88)

● AC Characteristics⁽²⁾(Continued)

Item	Symbol	Condition	min.	typ.	max.	Unit
CLK→RESET delay time	t _{CLL}				40	ns
CLK→POLK ↑ delay time	t _{CLPH}				22	ns
CLK→PCLK ↓ delay time	t _{CLPL}				22	ns
OSC→CLK ↑ delay time	t _{OLOH}		-5		22	ns
OSC→CLK ↓ delay time	t _{OLOL}		2		35	ns
Output rise time	t _{OLOH}	0.8 to 2.0 V for other than CPUCLK			20	ns
Output fall time	t _{OLOL}	2.0 to 0.8 V for other than CPUCLK			12	ns

● AC Characteristics⁽³⁾ Timer/Counter($V_{DD}=5V \pm 10\%$, $T_a=-20$ to $+75^{\circ}C$)

Item	Symbol	Condition	min.	typ.	max.	Unit
Clock cycle	t _{CLK}		200		DC	ns
Clock pulse width(H period)	t _{PWH}		80			ns
Clock pulse width(L period)	t _{PWL}		80			ns
Gate pulse width(H period)	t _{GW}		50			ns
Gate setting time(to CLK ↑)	t _{GS}		50			ns
Gate holding time(to CLK ↑)	t _{GH}		50			ns
Gate pulse width(L period)	t _{GL}		50			ns
Output delay time(to CLK ↓)	t _{OD}	$C_L=150pF$			150	ns
Output delay time(to GATE .)	t _{ODG}	$C_L=150pF$			120	ns

● AC Characteristics⁽⁴⁾ I/O Section($V_{DD}=5V \pm 10\%$, $T_a=-20$ to $+75^{\circ}C$)

Item	Symbol	Condition	min.	typ.	max.	Unit
WR=1 Output delay time	t _{WB}	$C_L=150pF$			350	ns
Peripheral data setting time to RD	t _{IR}		0			ns
Peripheral data holding time to RD	t _{IRHL}		0			ns
ACK pulse width	t _{AK}		300			ns
STB pulse width	t _{ST}		350			ns
Peripheral data setting time to STB	t _{PS}		0			ns
Peripheral data holding time to STB	t _{PH}		150			ns
ACK→Output delay time	t _{AD}				300	ns
ACK→Output float delay time	t _{KD}		20		250	ns
WR=1→OBF=0	t _{WOB}				300	ns
ACK=0→OBF=1	t _{AOB}				350	ns
STB=0→IBF=1	t _{SIB}				300	ns
RD=1→IBF=0	t _{RIB}				300	ns
RD=0→INTR=0	t _{TRIT}				400	ns
SBT=1→INTR=1	t _{TSIT}				300	ns
ACK=1→INTR=1	t _{TAIT}				350	ns
WR=0→INTR=0	t _{WTIT}				450	ns

Remark) At least, a reset pulse width of 50 μs is required during or immediately after power-on. Thereafter, 500 ns min. is sufficient.

● AC Characteristics⁽⁵⁾ Interrupt Controller($V_{DD} = 5V \pm 10\%$, $T_a = -20$ to $+75^\circ C$)

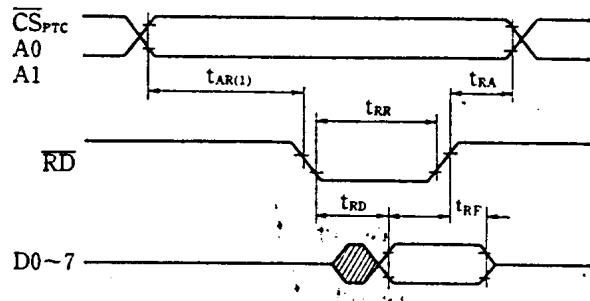
Item	Symbol	Condition	min.	typ.	max.	Unit
IR input pulse width	t_{JLJH}	Note)		100		ns
INT output delay time	t_{JHJH}				300	ns
INTA 1st-CAS delay time	t_{IALCV}	Master only			360	ns
INTA 2nd 3rd-CAS setting time	t_{CVIAL}	Slave only	40			ns
INTA pulse width	t_{RLRH}	Same as t_{RR} for RD read		120		ns
INTA read address setting time	t_{AHRL}	Same as $t_{AR(2)}$ for RD read	0			ns
INTA read address holding time	t_{RHAX}	Same as t_{RA} for RD read	0			ns
INTA read data delay time	t_{RLDV}				120	ns
Address(CS, PINT, A0)read data delay time	t_{AHDV}	Applied to both RD and INTA read			200	ns
INTA read data holding time	t_{RHDX}		10		85	ns
CAS read data delay time	t_{CVDV}				200	ns
INTA recovery time	t_{RHRL}	At an identical sequence	160			ns
	t_{CHCL}	At other INTA sequence	250			ns
EN pulse delay time	t_{RLEL}	$\overline{RD} \downarrow / \overline{INTA} \downarrow - \overline{EN} \downarrow$			100	ns
EN pulse holding time	t_{RHEN}	$\overline{RD} \uparrow / \overline{INTA} \uparrow - \overline{EN} \uparrow$			150	ns

Note) Time required to clear the input latch in the edge trigger mode

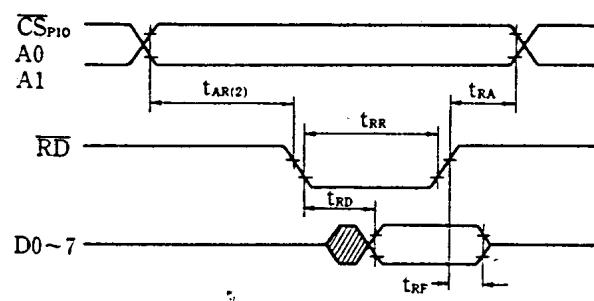
■ AC Timing Diagrams

(1) Read Cycles

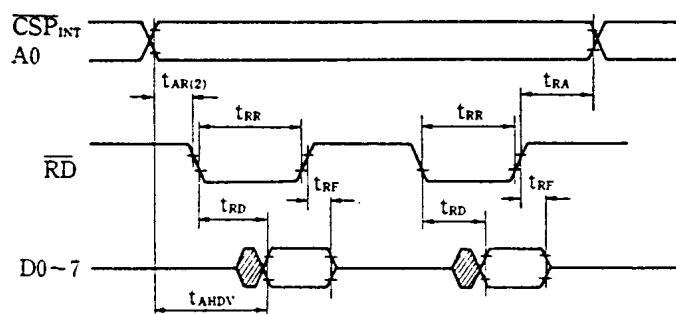
1.Timer/counter read cycle



2.I/O section read cycle(same as Mode-0 Input)

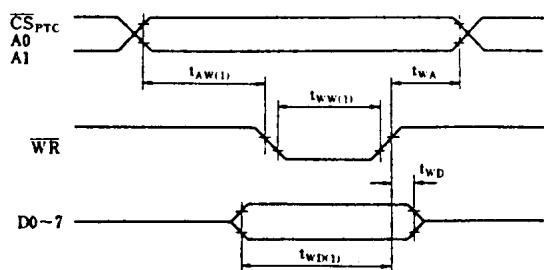


3.Inputtupt controller read cycle

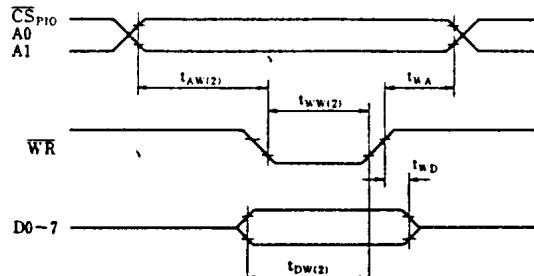


(2) Write Cycles

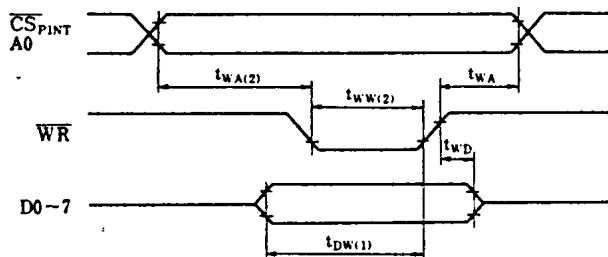
1. Timer/Counter



2. I/O section

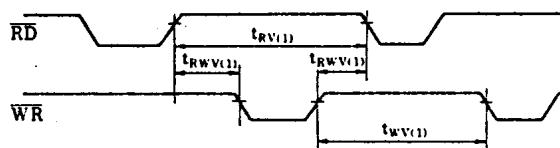


3. Interrupt controller

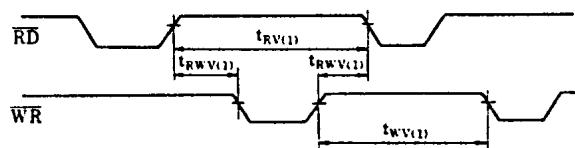


(3) Read/Write Bus Recovery Time

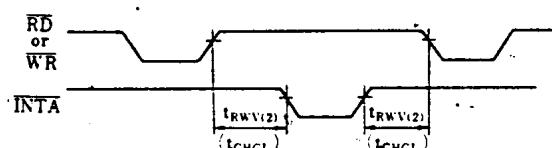
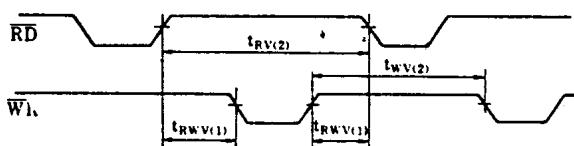
1. Timer/counter



2. I/O section

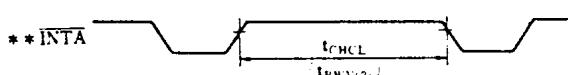
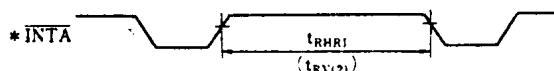


3. Interrupt controller



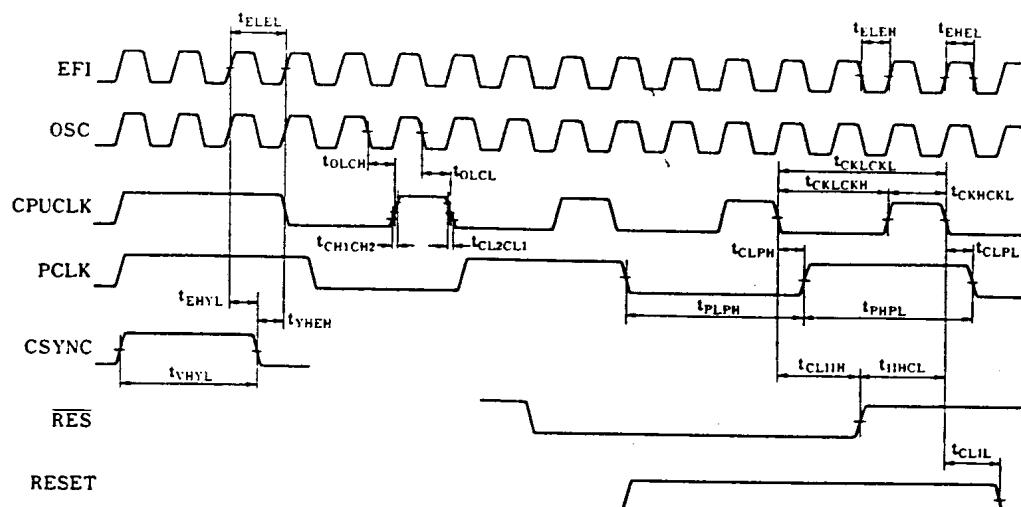
* INTA operates identical with the RD signal. This timing applies to continuous vector read.

** Applies to new vector read for another interrupt cause after completing one vector read of INTA.



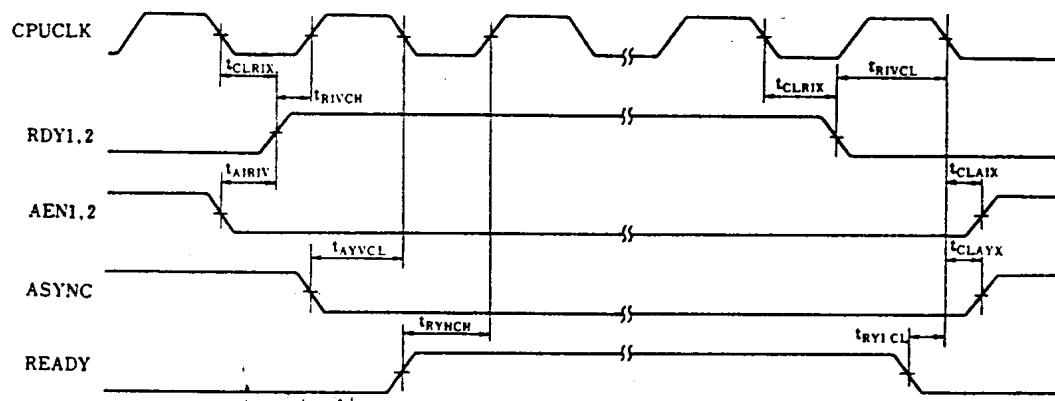
(4) Clock Generator

- CPUCLK and RESET signals

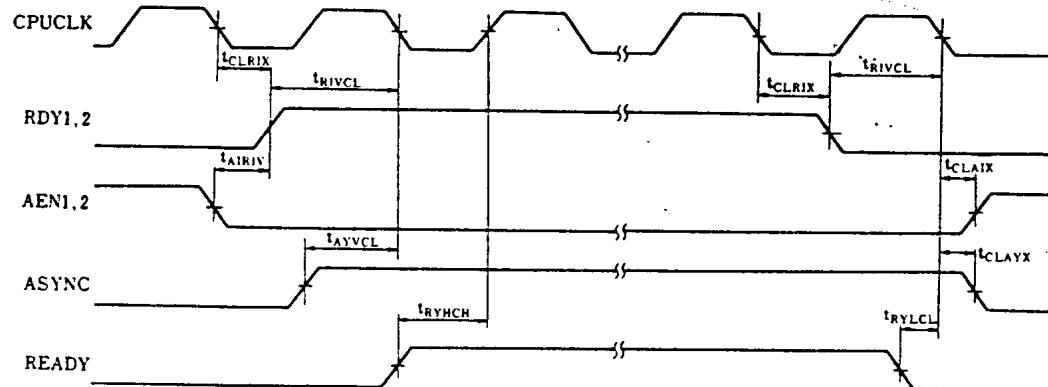


Note) A timing measuring point is at 1.5 V, unless otherwise specified.

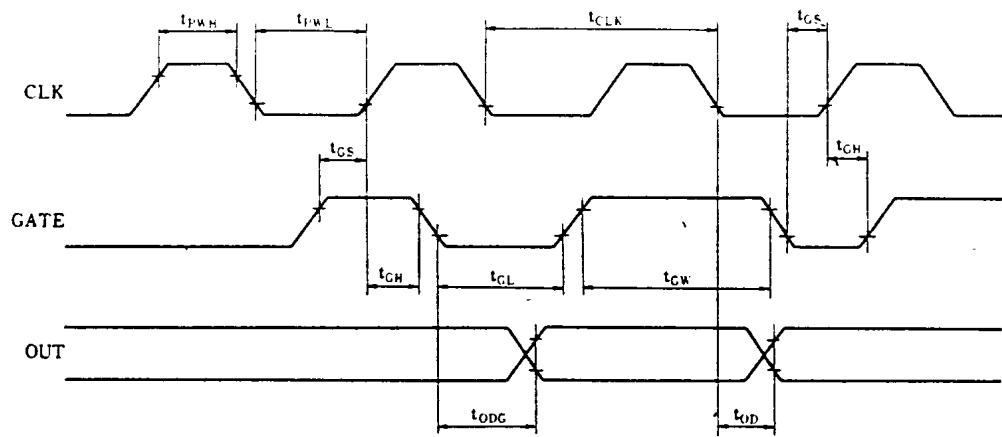
• READY signal(Async. device)



• READY signal(Sync. device)

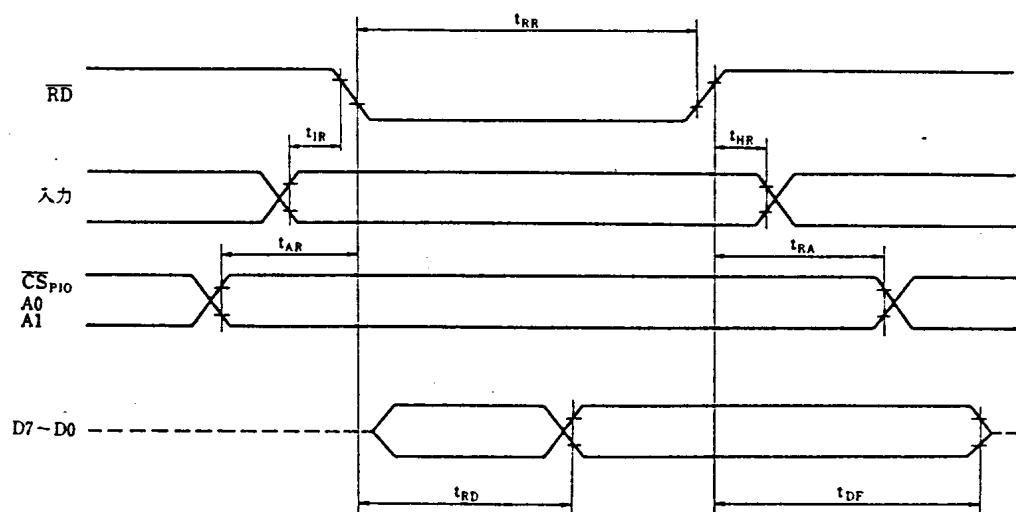


(5) Timer/Counter

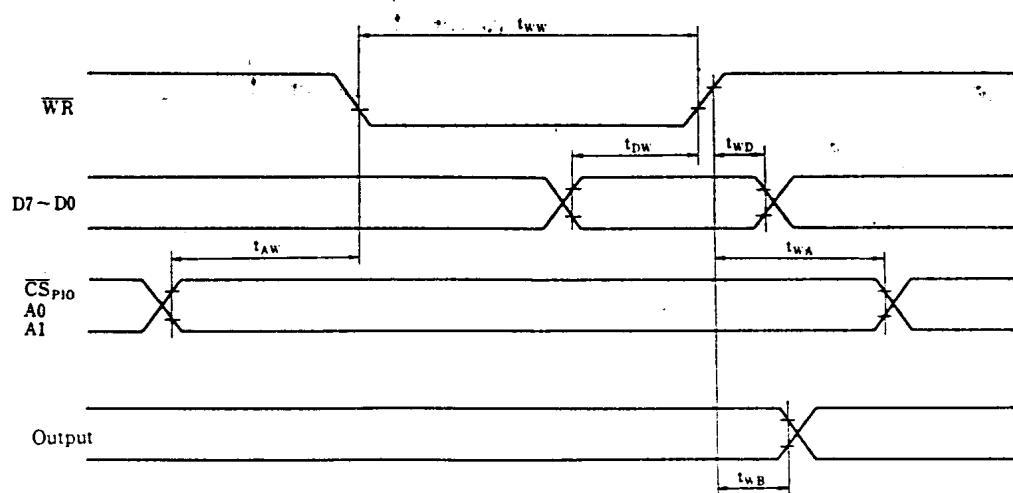


(6) I/O Section

● Mode-O input



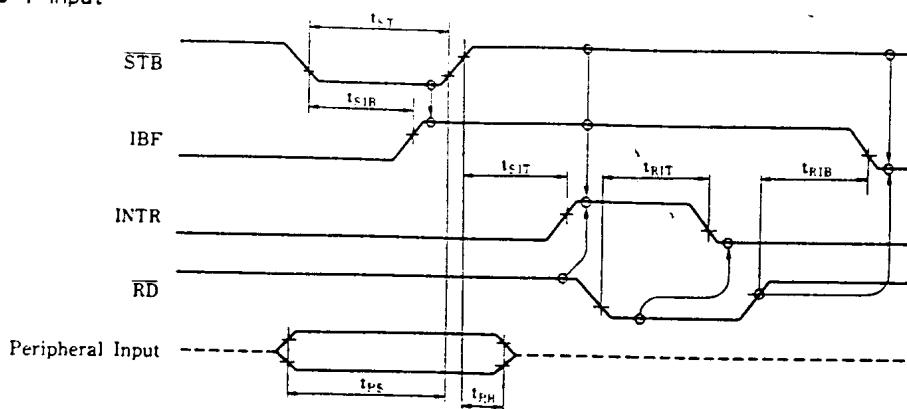
● Mode-O output



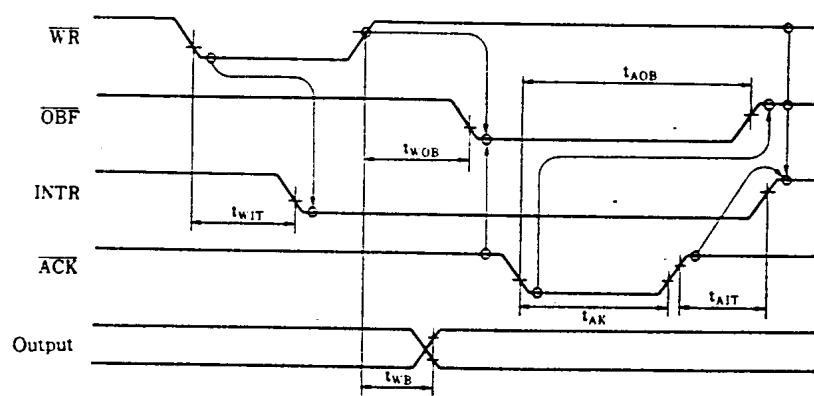
16-Bit Microprocessors/Peripheral LSIs

MN12861

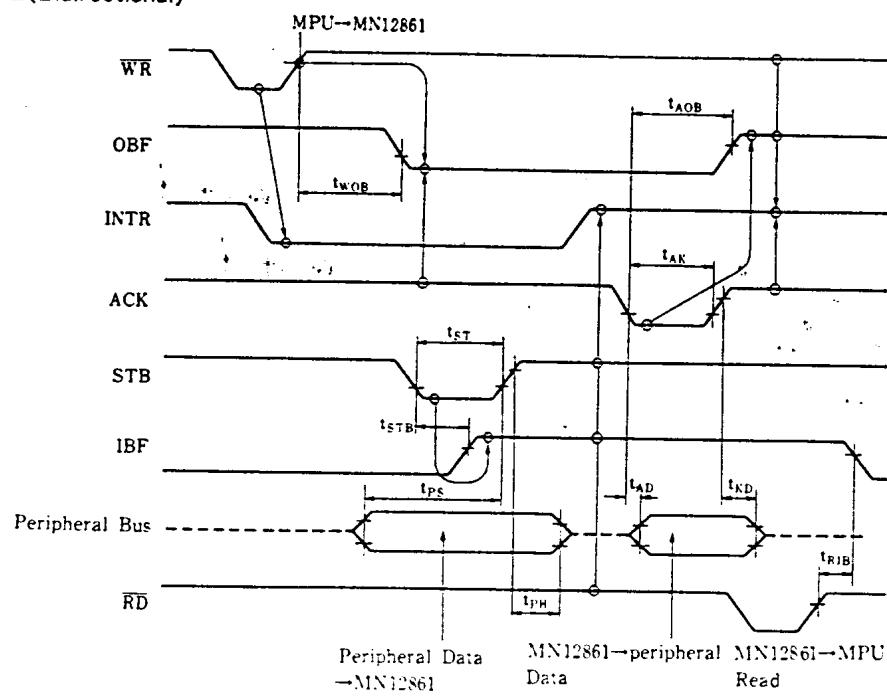
● Mode-1 input



● Mode-1 output

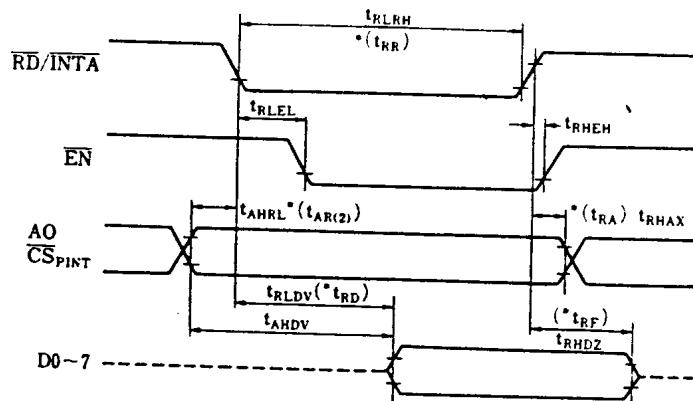


● Mode 2 (Bidirectional)

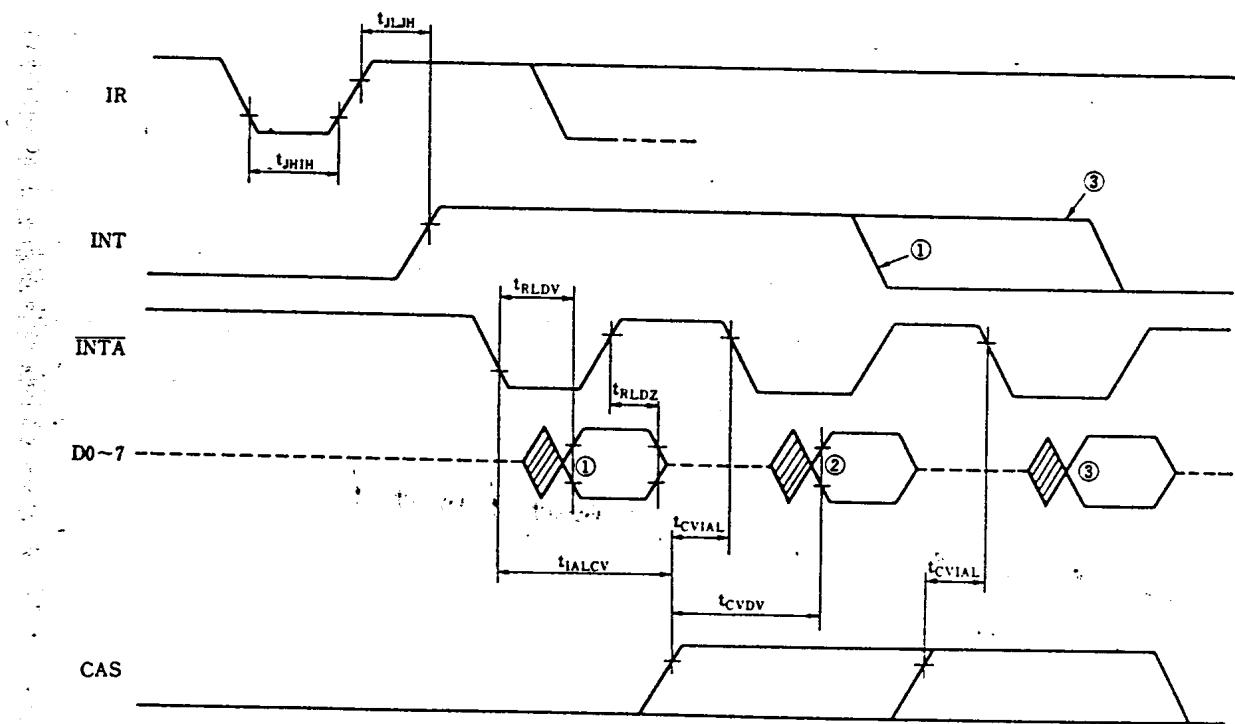


(7) Interrupt Controller

1. Read, interrupt acknowledge operation (* : RD operation time)



2. Interrupt sequence



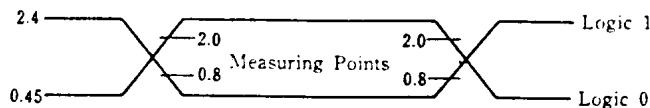
Remark: INT output must keep High at least until the front edge of 1st INTA.

① Cycle 1 in the 8086/8088 system. The data bus is not driven.

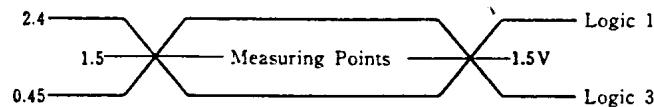
② 8080/8085 system only

■ I/O Waveforms for AC Test

- Other than Clock Generator

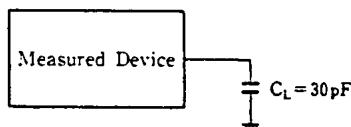


- Clock Generator

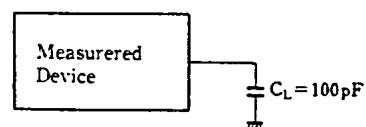


■ Load Conditions

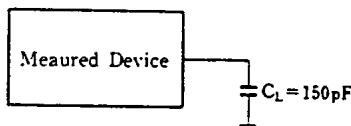
- OSC, PCLK, READY, RESET



- CPUCLK

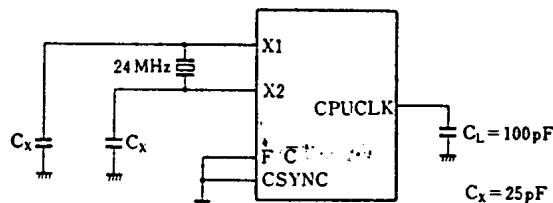


- All Output Terminals other than 5 Terminals Above

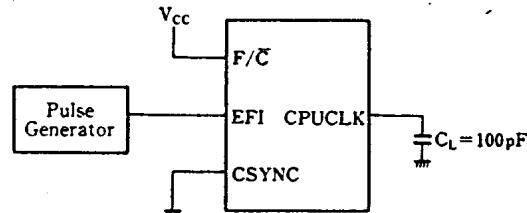


■ Measuring Circuits

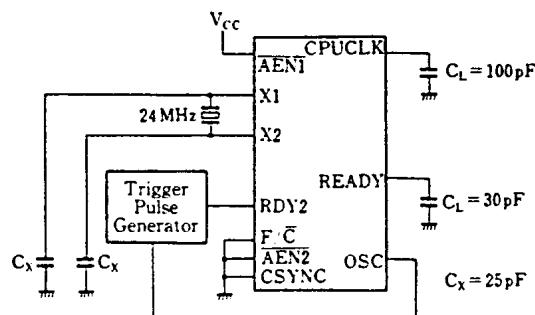
- CPUCLK High/Low Level Width Measuring Circuit (When X1, X2 Used)



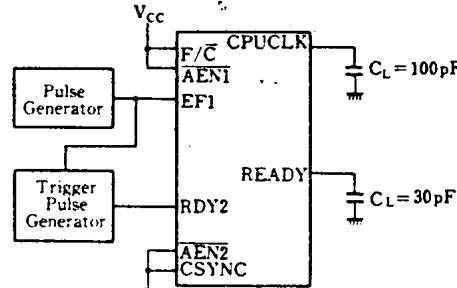
- CPUCLK High/Low Level Width Measuring Circuit (When EFI Used)



- Ready vs. CPUCLK Time Measuring Circuit (When X1, X2 Used)



- Ready vs. CPUCLK Time Measuring Circuit (When EFI Used)



■ MN12861 Address Setting(Table 1)

WR	RD	CS PTC	CS PIO	CS PINT	INTA	D 0 ~ 7	Data Bus Operation
1	0	0	1	1	1	OUT	Timer Counter →Data
1	0	1	0	1	1	OUT	I/O section →Data
1	0	1	1	0	1	OUT	Interrupt controller →Data
1	1	1	1	1	0	OUT	Interrupt controller →Data
0	1	0	1	1	1	IN	Data→Timer counter
0	1	1	0	1	1	IN	Data→I/O section
0	1	1	1	0	1	IN	Data→Interrupt controller
1	1	X	X	X	1	Z	Data bus high impedance
X	X	1	1	1	1	Z	Data bus high impedance
0	0	X	X	X	X	-	Prohibited
X	X	0	0	0	X	-	Prohibited
1	0	0	X	X	0	-	Prohibited
1	0	X	0	X	0	-	Prohibited
1	0	X	X	0	0	-	Prohibited
0	1	0	X	X	0	-	Prohibited
0	1	X	0	X	0	-	Prohibited
0	1	X	X	0	0	-	Prohibited

Note) X denotes either 0(L) or 1(H).

■ I/O Section Address Setting(Table 2)

D7	A1	A0	WR	RD	CS PIO	Operation
X	0	0	1	0	0	PA→D
X	0	1	1	0	0	PB→D
X	1	0	1	0	0	PC→D
X	1	1	1	0	0	Prohibited
X	0	0	0	1	0	D→PA
X	0	1	0	1	0	D→PB
X	1	0	0	1	0	D→PC
0	1	1	0	1	0	D→CWRIO
1	1	1	0	1	0	D→Bit control
X	X	X	X	X	1	D0-D7 high impedance
X	X	X	1	1	0	D0-D7 high impedance

■ Timer/Counter Address Setting(Table 3)

A1	A0	WR	RD	CS PIO	Bus Operation
0	0	1	0	0	Read from the counter #0
0	1	1	0	0	Read from the counter #1
1	0	1	0	0	Read from the counter #2
1	1	1	0	0	No operation(high impedance)
0	0	0	1	0	Write to the counter #0
0	1	0	1	0	Write to the counter #1
1	0	0	1	0	Write to the counter #2
1	1	0	1	0	Write to CWRJC
X	X	1	1	1	Disable(high impedance)
X	X	1	1	0	No operation(high impedance)

■ Interrupt Control Address Setting (Table 4)

D4	D3	A0	WR	RD	CS PINT	INTA	Bus Operation
X	X	0	1	0	0	1	IRR, ISR, interrupt level read ^{Note 1)}
X	X	1	1	0	0	1	Read from IMR
0	0	0	0	1	0	1	Write to OCW2
0	1	0	0	1	0	1	Write to OCW3
1	X	0	0	1	0	1	Write to ICW1
X	X	1	0	1	0	1	Write to ICW4 ^{Note 2)}
<hr/>							
X	X	X	1	1	0	1	High impedance
X	X	X	X	X	1	1	High impedance
X	X	X	1	1	1	0	Interrupt vector read

Note 1) OCW3 changes what is read.

Note 2) Write operation is sequentially performed by the sequence circuit.